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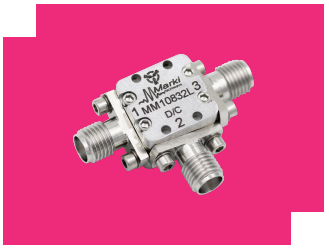
MM1-0832LS

GaAs MMIC Double Balanced Mixer

DEVICE OVERVIEW

General Description

The MM1-0832L is a GaAs MMIC double balanced mixer that is designed for and operates at X through K bands. MM1-0832L is a low power K band mixer that works well as both an up and down converter. This mixer offers low conversion loss and high LO to RF isolation over a broadband X to K band. The sister component MM1-0832H is recommended for high linearity applications. The MM1-0832L is available as both a wire bondable die and as a connectorized module.



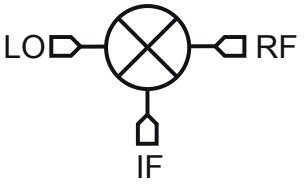
Features

- Low +7 dBm minimum LO drive
- Low cost K band mixer
- Broadband Performance
- RoHS Compliant

Applications

- Mobile test and measurement equipment
- Power efficient modules
- 5G
- Radar

Functional Block Diagram



Part Ordering Options

Part Number	Description	Package	Connectors	Green Status	Product Lifecycle	Export Classification
MM1-0832LS	GaAs MMIC Double Balanced Mixer	S	Standard	REACH RoHS	Released	EAR99

Table Of Contents

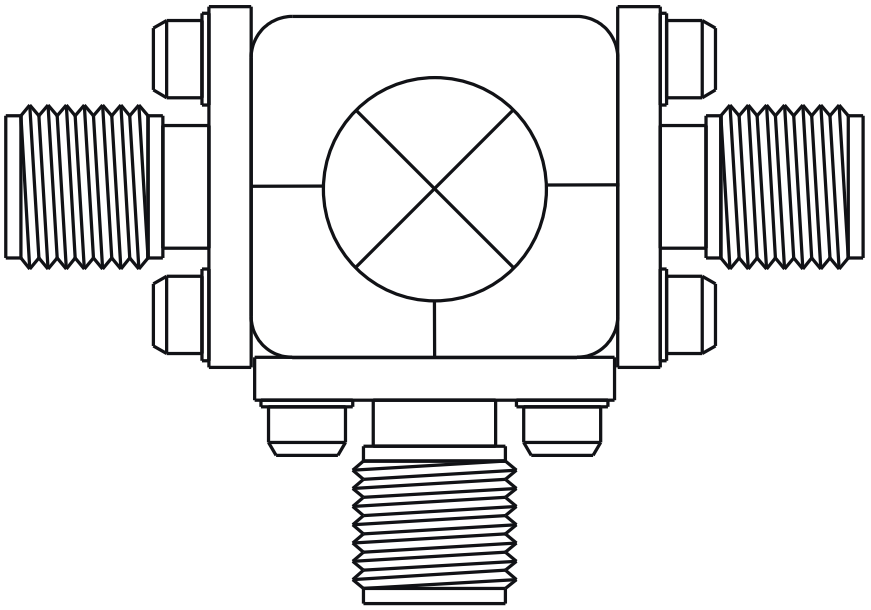
Revision History

Revision Code	Revision Date	Comment
-	2018-10-01	Datasheet Initial Release

Port Configuration and Functions

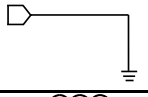
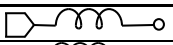
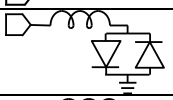
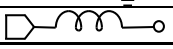
Port Diagram

The MM1-0832L has the input and output ports given in Port Functions. The MM1-0832L can be used in either an up or down conversion. For configuration A, input the LO into port 1, use port 3 for the RF, and port 2 for the IF. For configuration B, input the LO into port 3, use port 1 for the RF, and port 2 for the IF.

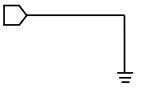
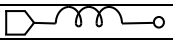
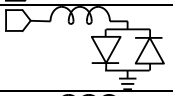
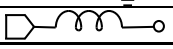


Port Functions

Configuration A

Port	Function	Connector Type	Description	Equivalent Circuit for Package
GND	Ground	-	S package ground provided through metal housing and outer coax conductor.	
Port 1	LO	2.92F	Port 1 is DC open for the CH and S packages.	
Port 2	IF	SMAF	Port 2 is diode connected for the CH and S packages.	
Port 3	RF	2.92F	Port 3 is DC open for the CH and S packages.	

Configuration B

Port	Function	Connector Type	Description	Equivalent Circuit for Package
GND	Ground	-	S package ground provided through metal housing and outer coax conductor.	
Port 1	RF	2.92F	Port 1 is DC open for the CH and S packages.	
Port 2	IF	SMAF	Port 2 is diode connected for the CH and S packages.	
Port 3	LO	2.92F	Port 3 is DC open for the CH and S packages.	

Specifications

Absolute Maximum Ratings

The Absolute Maximum Ratings indicate limits beyond which damage may occur to the device. If these limits are exceeded, the device may be inoperable or have a reduced lifetime.

Parameter	Maximum Rating	Unit
Maximum Operating Temperature	100	°C
Maximum Storage Temperature	125	°C
Minimum Operating Temperature	-55	°C
Minimum Storage Temperature	-65	°C
Power Handling, any Port	30	dBm

Package Information

Parameter	Details	Rating
ESD	250 to < 500 Volts	HBM Class 1A
Weight	Package name: S	12g
Dimensions	-	14.22 x 13.21 mm

Recommended Operating Conditions

The Recommended Operating Conditions indicate the limits, inside which the device should be operated, to guarantee the performance given in Electrical Specifications Operating outside these limits may not necessarily cause damage to the device, but the performance may degrade outside the limits of the electrical specifications. For limits, above which damage may occur, see Absolute Maximum Ratings.

Parameter	Min	Nominal	Max	Unit
Ambient Temperature	-55	25	100	°C
LO Input Power	7	-	15	dBm

Sequencing Requirements

There is no requirement to apply power to the ports in a specific order. However, it is recommended to provide a 50Ω termination to each port before applying power. This is a passive diode mixer that requires no DC bias.

Electrical Specifications

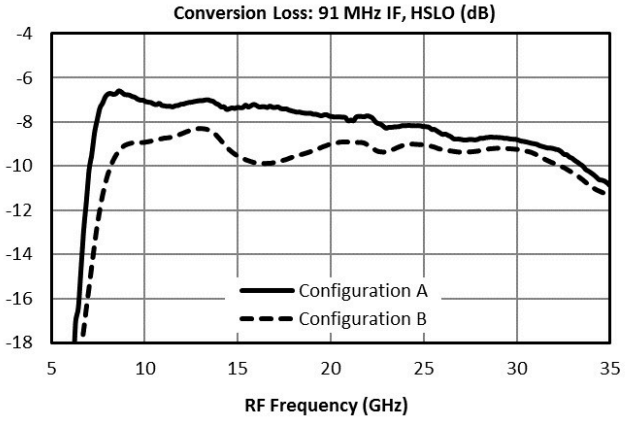
The electrical specifications apply at TA=+25°C in a 50Ω system. Typical data shown is for the connectorized S package mixer used in the forward direction with a +9 dBm sine wave input. Min and Max limits apply only to our connectorized units and are guaranteed at TA=+25°C. All bare die are 100% DC tested and visually inspected.

Parameter	Port Configuration	Test Conditions	Min	Typ	Max	Unit
Conversion Loss [1]	A	RF/LO = 8 - 32 GHz I = 4 - 12 GHz	-	9.5	-	dB
Conversion Loss [2]	A	RF/LO = 8 - 32 GHz I = DC - 4 GHz	-	8	10	dB
Input 1 dB Gain Compression Point (P1dB)	A	-	-	2	-	dBm
Input IP3	A	RF/LO = 8 - 32 GHz I = DC – 0.2 GHz	-	13.5	-	dBm
Conversion Loss [3]	B	RF/LO = 8 - 32 GHz I = 4 - 12 GHz	-	11	-	dB
Conversion Loss [4]	B	RF/LO = 8 - 32 GHz I = DC - 4 GHz	-	9.5	11.5	dB
Input 1 dB Gain Compression Point (P1dB)	B	-	-	4	-	dBm
Input IP3	B	RF/LO = 8 - 32 GHz I = DC – 0.2 GHz	-	15	-	dBm
IF Frequency Range	-	-	0	-	12	GHz
Isolation, LO to IF	-	IF/LO = 8 - 32 GHz	-	34	-	dB
Isolation, LO to RF	-	RF/LO = 8 - 32 GHz	-	46	-	dB
Isolation, RF to IF	-	RF/IF = 8 - 32 GHz	-	35	-	dB
LO Frequency Range	-	-	8	-	32	GHz
Noise Figure [5]	-	RF/LO = 8 - 32 GHz I = DC – 0.2 GHz	-	8.5	-	dB
RF Frequency Range	-	-	8	-	32	GHz

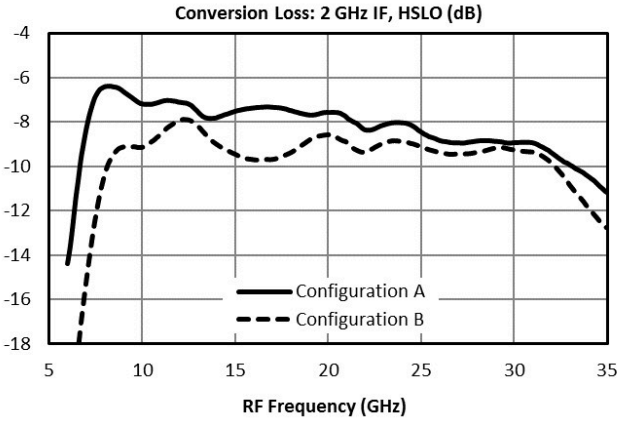
[1] Measured as a down converter to a fixed 91MHz IF.
[2][3] Measured as a down converter to a fixed 91MHz IF.
[4] Measured as a down converter to a fixed 91MHz IF
[5] Mixer Noise Figure typically measures within 0.5 dB of conversion loss for IF frequencies greater than 5 MHz.

Typical Performance Plots

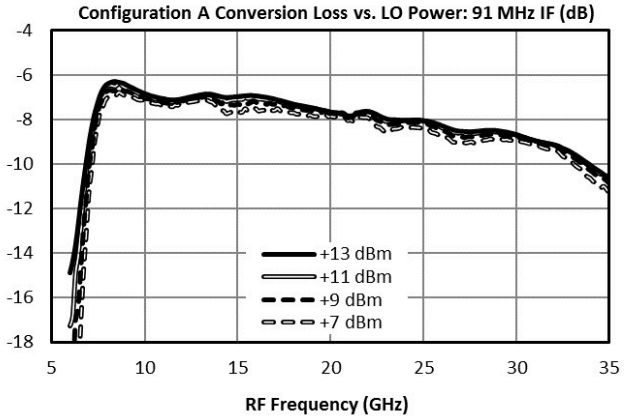
Conversion Loss: 91 MHz IF, HSLO (dB)



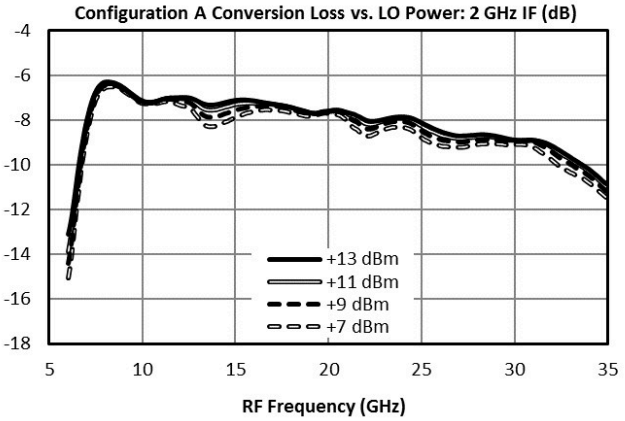
Conversion Loss: 2 GHz IF, HSLO (dB)



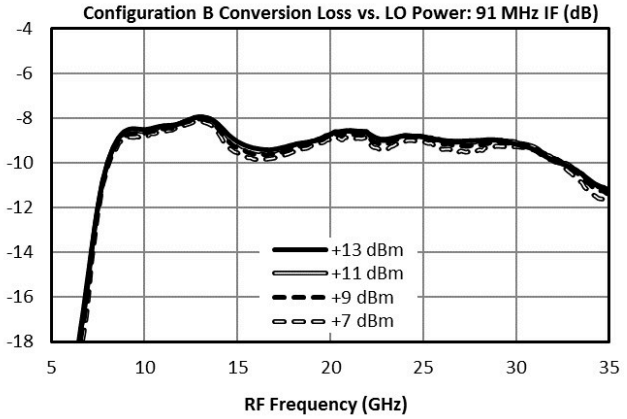
Configuration A Conversion Loss vs. LO Power: 91 MHz IF (dB)



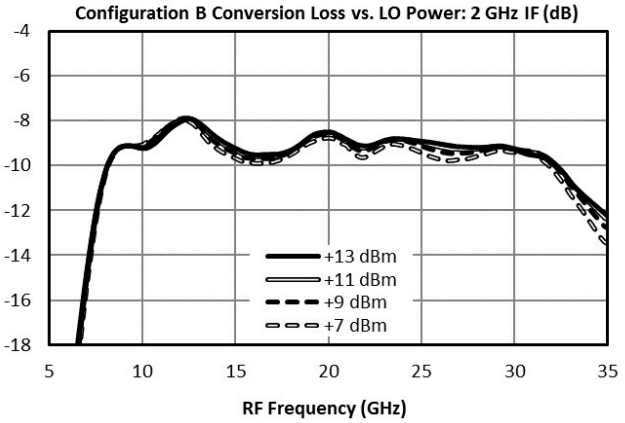
Configuration A Conversion Loss vs. LO Power: 2 GHz IF (dB)



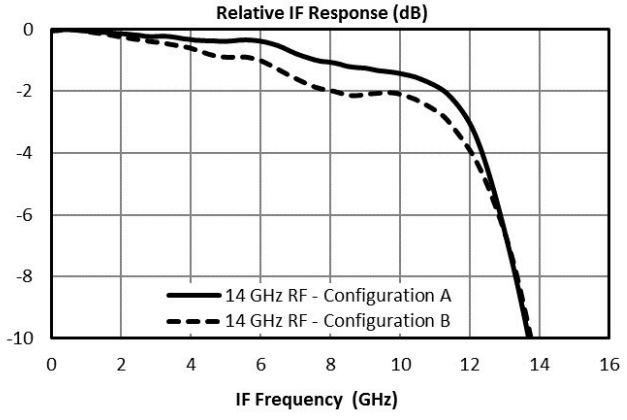
Configuration B Conversion Loss vs. LO Power: 91 MHz IF (dB)



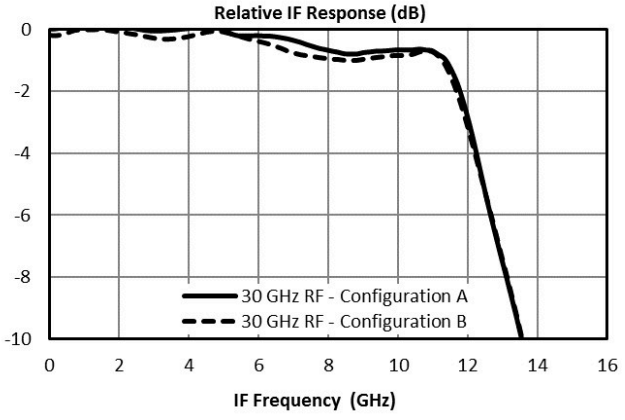
Configuration B Conversion Loss vs. LO Power: 2 GHz IF (dB)

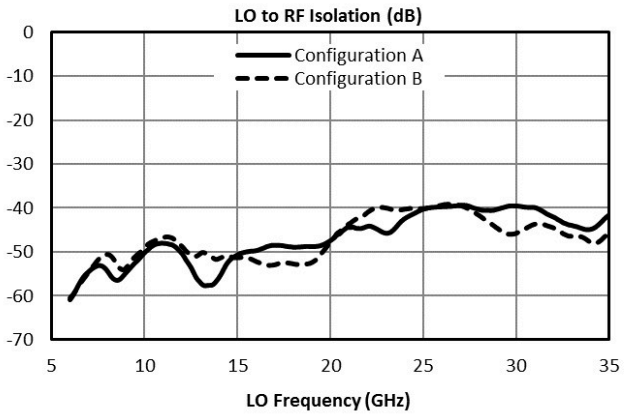


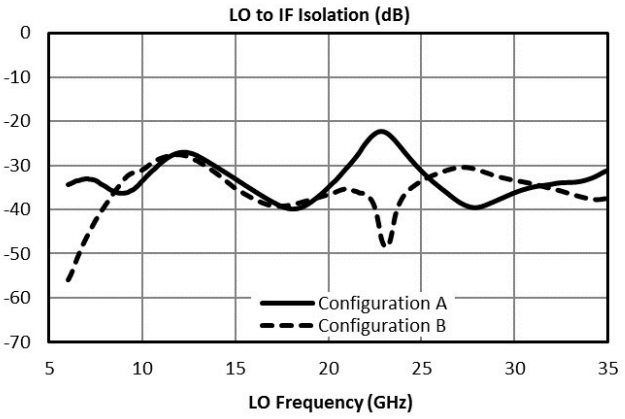
Relative IF Response (dB)

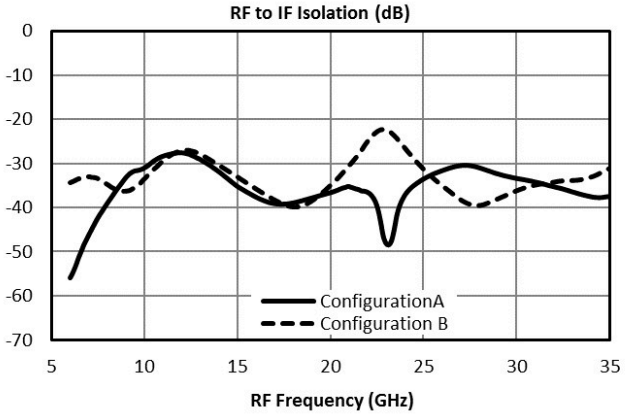


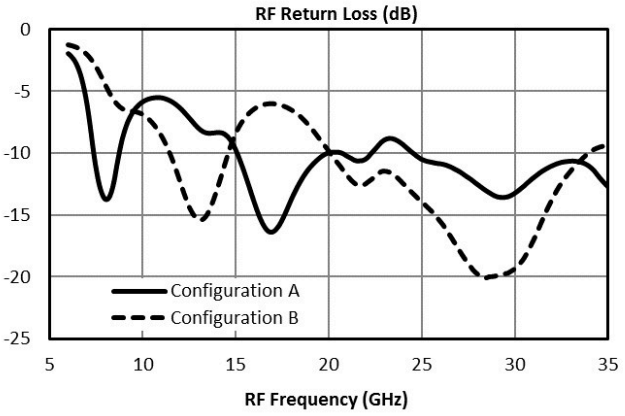
Relative IF Response (dB)

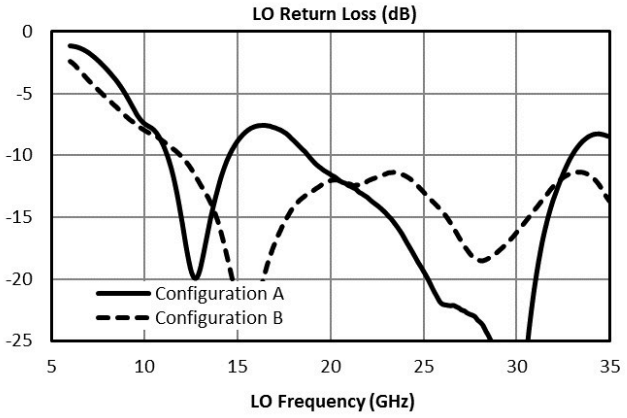


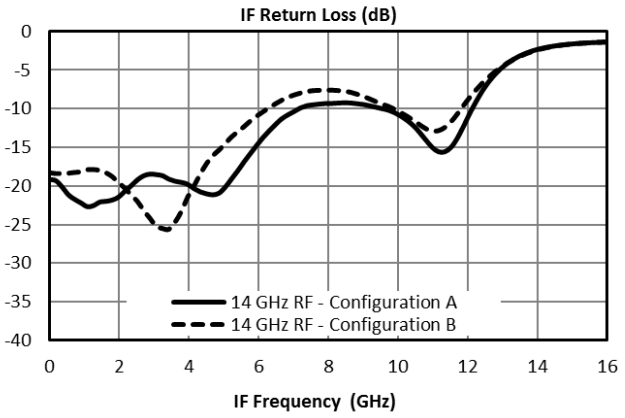


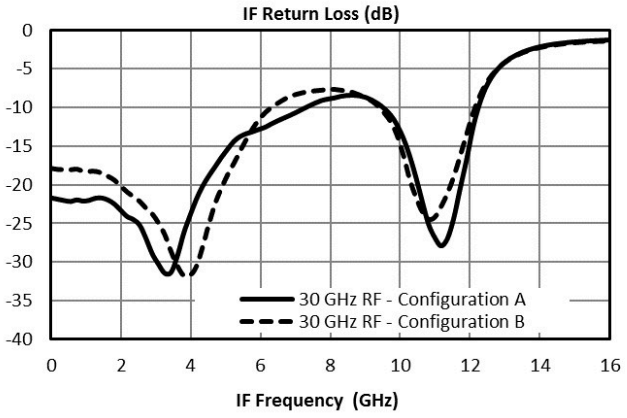




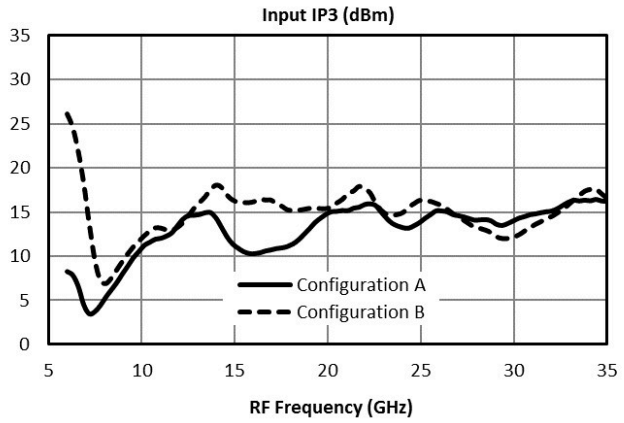


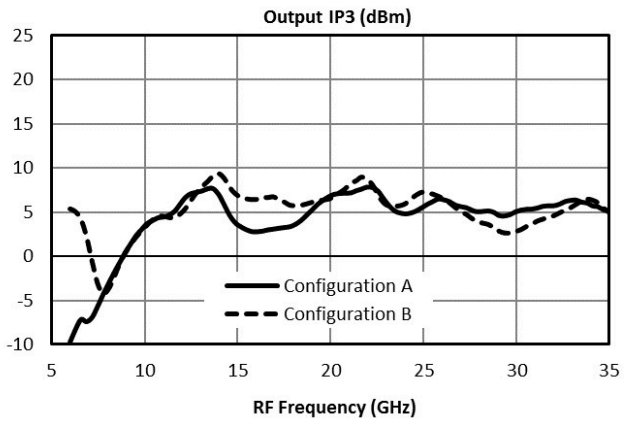


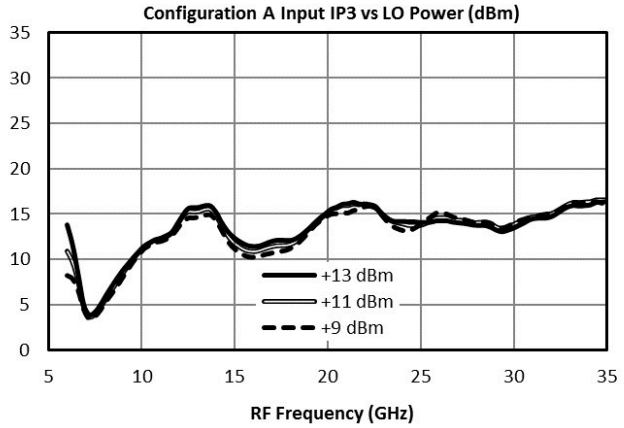


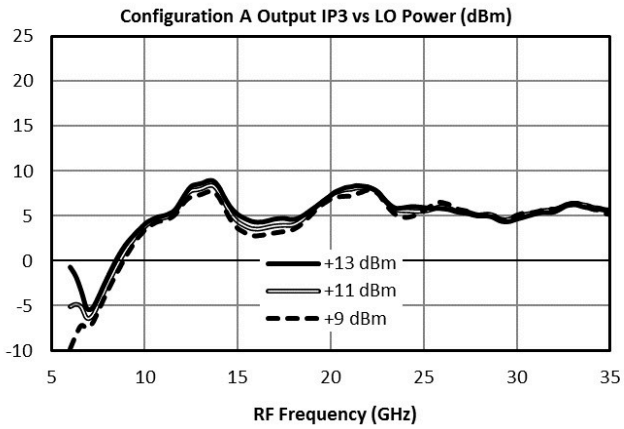


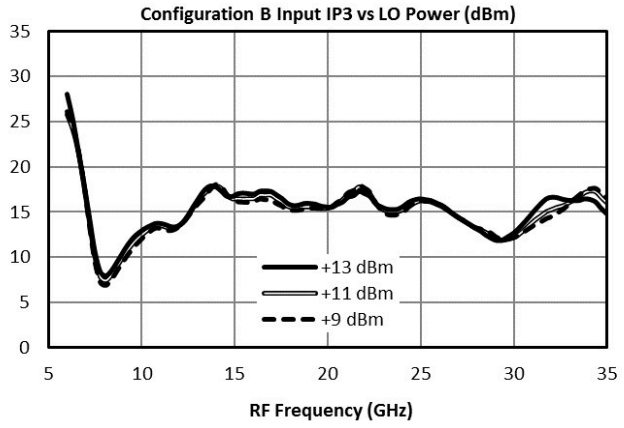
Typical Performance Plots: IP3

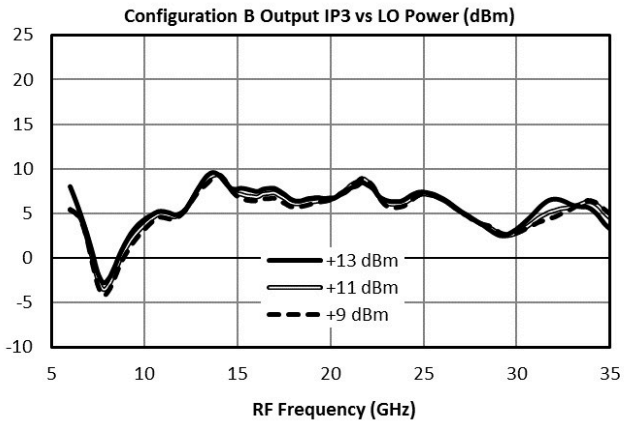




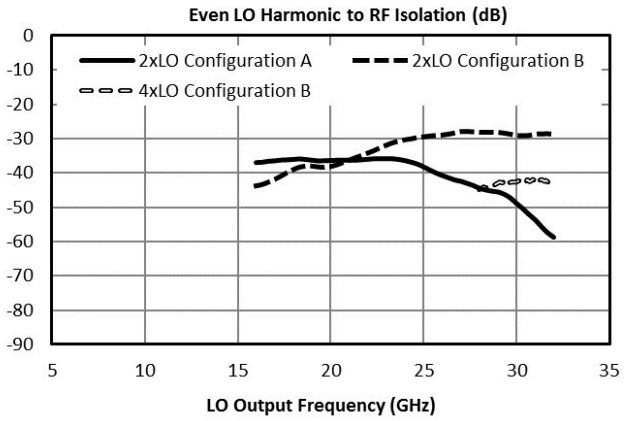


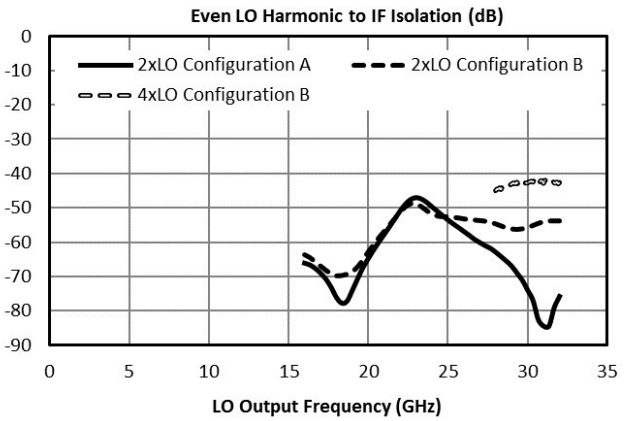


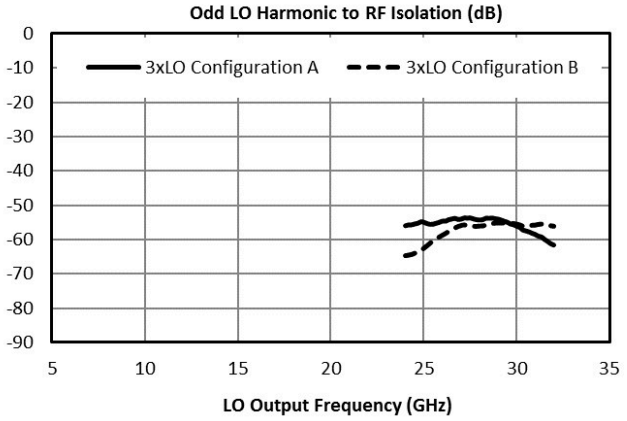


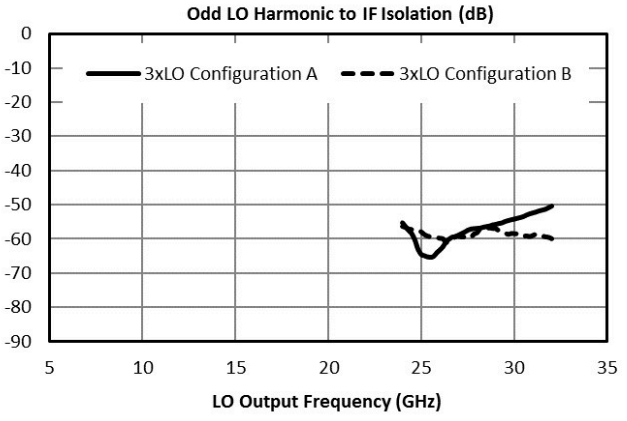


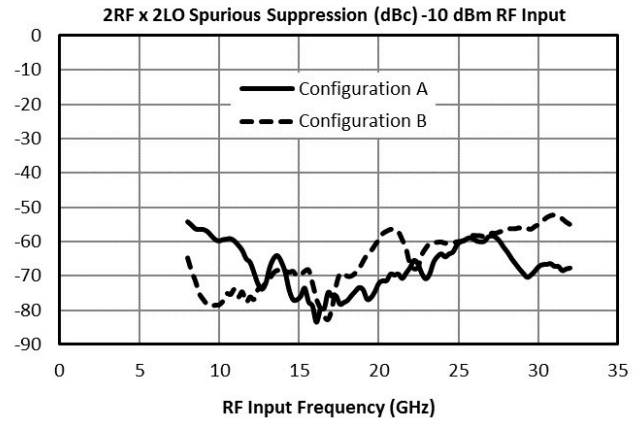
Typical Performance Plots: LO Harmonic Isolation

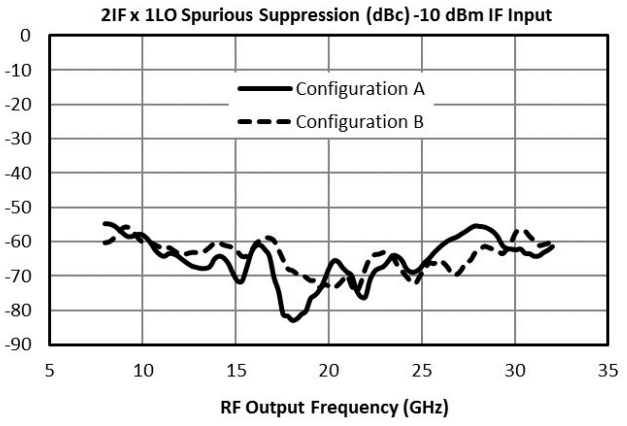












Spur Table

Typical Spurious Performance: Down-Conversion

Typical spurious data is provided by selecting RF and LO frequencies (± m*LO ± n*RF) within the RF/LO bands, to create a spurious output within the IF band. The mixer is swept across the full spurious band and the mean is calculated. The numbers shown in the table below are for a -10 dBm RF input. Spurious suppression is scaled for different RF power levels by (n-1), where "n" is the RF spur order. For example, the 2RF x 2LO spur is 67 dBc for a -10 dBm input, so a -20 dBm RF input creates a spur that is (2-1) x (-10 dB) lower, or 77 dBc. Data is shown for the frequency plan in 3.6 Typical Performance.

Typical Down-conversion spurious suppression (dBc): Config A (B)

-10 dBm RF Input	0xLO	1xLO	2xLO	3xLO	4xLO	5xLO
1xRF	27 (24)	Reference	30 (36)	13 (13)	41 (42)	29 (31)
2xRF	72 (80)	57 (40)	67 (65)	57 (47)	64 (71)	51 (49)
3xRF	86 (92)	48 (48)	68 (85)	57 (58)	64 (78)	53 (58)
4xRF	109 (122)	95 (87)	96 (94)	100 (85)	101 (99)	99 (84)
5xRF	N/A	92 (91)	90 (101)	93 (103)	105 (117)	98 (99)

Typical Spurious Performance: Up-Conversion

Typical spurious data is taken by mixing an input within the IF band, with LO frequencies (± m*LO ± n*IF), to create a spurious output within the RF output band. The mixer is swept across the full spurious output band and the mean is calculated. The numbers shown in the table below are for a -10 dBm IF input. Spurious suppression is scaled for different IF input power levels by (n-1), where "n" is the IF spur order. For example, the 2IFx1LO spur is typically 65 dBc for a -10 dBm input with a sine-wave LO, so a -20 dBm IF input creates a spur that is (2-1) x (-10 dB) lower, or 75 dBc. Data is shown for the frequency plan in 3.6 Typical Performance.

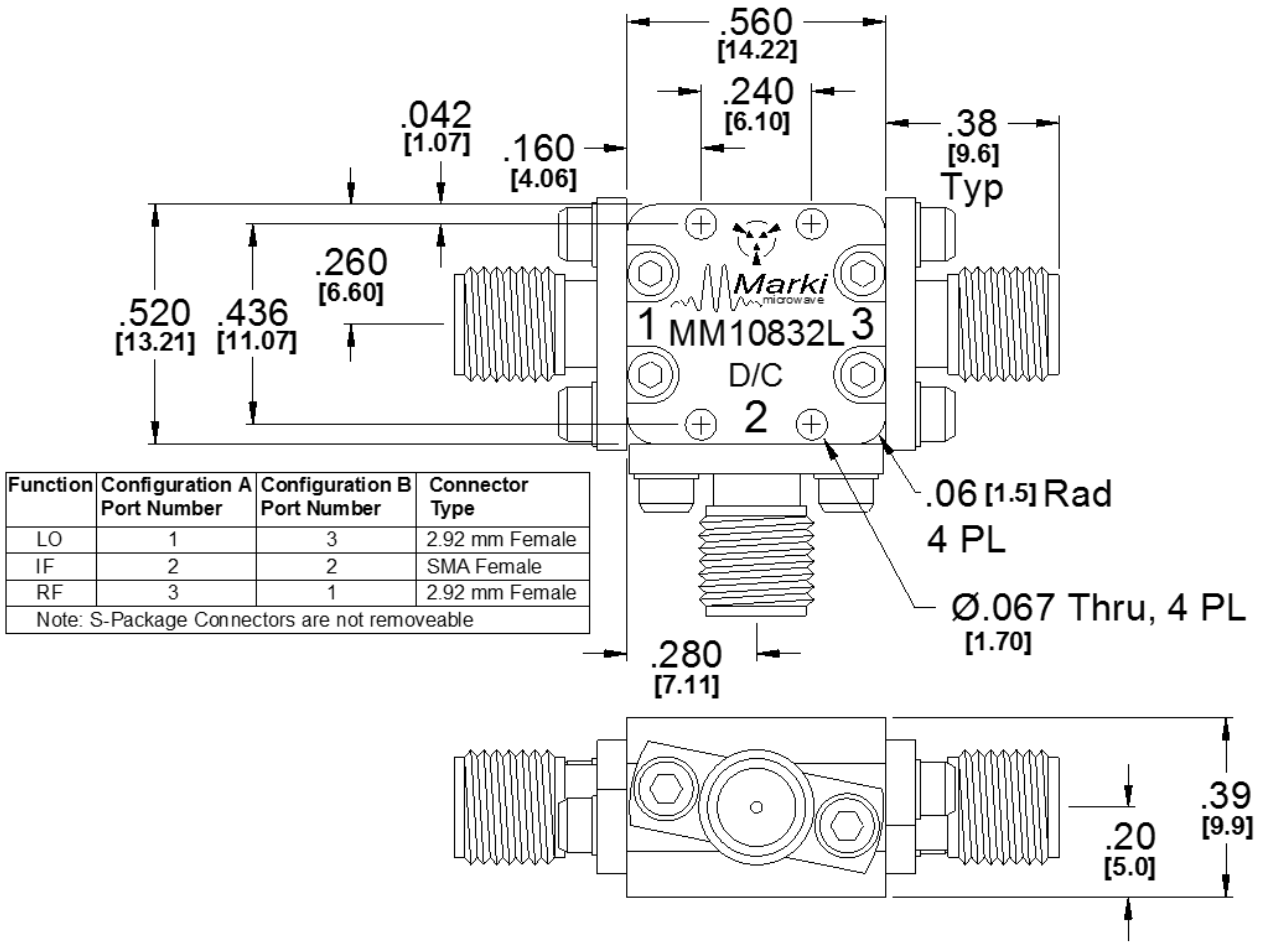
Typical Up-conversion spurious suppression (dBc): Config A (B)

-10 dBm RF Input	0xLO	1xLO	2xLO	3xLO	4xLO	5xLO
1xIF	27 (24)	Reference	32 (38)	14 (12)	37 (38)	29 (25)
2xIF	63 (58)	65 (64)	49 (39)	57 (70)	58 (41)	66 (74)
3xIF	80 (87)	56 (55)	61 (73)	50 (46)	63 (78)	56 (51)
4xIF	99 (82)	101 (100)	92 (79)	90 (103)	77 (78)	98 (105)
5xIF	107 (118)	89 (90)	100 (110)	86 (78)	98 (111)	79 (83)

Mechanical Data

Outline Drawing

Download : Outline 2D Drawing | Outline 3D Drawing | Outline 3D STP



Function	Configuration A Port Number	Configuration B Port Number	Connector Type
LO	1	3	2.92 mm Female
IF	2	2	SMA Female
RF	3	1	2.92 mm Female
Note: S-Package Connectors are not removeable			

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